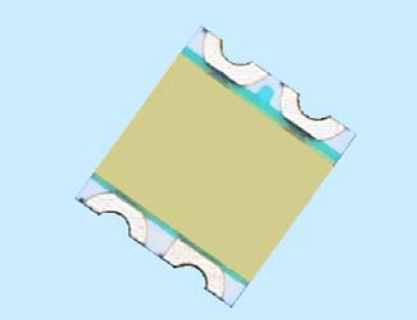
EVERLIGHT AMERICAS

DATASHEET

SMD ▪ B
EAST1615AWA0



Features

- Package in 8mm tape on 7″ diameter reel.
- Compatible with automatic placement equipment.
- Compatible with infrared and vapor phase reflow solder process.
- Multi-color type.
- Pb-free.
- ESD Protection.
- The product itself will remain within RoHS compliant version.
- Compliance with EU REACH.
- Compliance Halogen Free .(Br <900 ppm ,Cl <900 ppm , Br+Cl < 1500 ppm).

Description

- The SMD LED is much smaller than lead frame type components, thus enable smaller board size, higher packing density, reduced storage space and finally smaller equipment to be obtained.
- Besides, lightweight makes them ideal for miniature applications. etc.

Applications

- Backlighting in dashboard and switch.
- Telecommunication: indicator and backlighting in telephone and fax.
- Flat backlight for LCD, switch and symbol.
- General use.

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Device Selection Guide

Code	Chip Materials	Emitted Color	Resin Color
S2	AlGaInP	Brilliant Orange	Yellow Diffused
T1	InGaN	Pure White	

Absolute Maximum Ratings (Ta=25℃)

Parameter	Symbol	Code	Rating	Unit
Reverse Voltage	V_R		5	V
Forward Current	I_F		25	mA
Peak Forward Current (Duty 1/10 @1KHz)	I_{FP}	S2	60	mA
		T1	100	
Power Dissipation	Pd	S2	60	mW
		T1	95	
Electrostatic Discharge	ESD_{HBM}	S2	2000	V
		T1	150	
Operating Temperature	T_{opr}		-40 ~ +85	℃
Storage Temperature	Tstg		-40 ~ +90	℃
Soldering Temperature	Tsol		Reflow Soldering : 260 ℃ for 10 sec. Hand Soldering : 350 ℃ for 3 sec.	

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Electro-Optical Characteristics (Ta=25℃)

Parameter	Symbol	Code	Min.	Typ.	Max.	Unit	Condition
Luminous Intensity	Iv	S2	18.0	-----	45.0	mcd	I_F=5mA
		T1	45.0	-----	112		
Viewing Angle	$2\theta_{1/2}$		-----	140	-----	deg	
Peak Wavelength	λ p	S2	-----	611	-----	nm	
Dominant Wavelength	λ d	S2	600.5	-----	609.5	nm	
Spectrum Radiation Bandwidth	△ λ	S2	-----	17	-----	nm	
Forward Voltage	V_F	S2	1.70	----	2.40	V	
		T1	2.70	----	3.70		
Reverse Current	I_R	S2	-----	-----	10	μA	V_R=5V
		T1	-----	-----	50		

Note:
1.Tolerance of Luminous Intensity: ±11%
2.Tolerance of Dominant Wavelength ±1nm
3.Tolerance of Forward Voltage: ±0.10V

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Bin Range of Luminous Intensity
S2

Bin Code	Min.	Max.	Unit	Condition
M	18.0	28.5	mcd	I_F =5mA
N	28.5	45.0		

Bin Range of Luminous Intensity
T1

Bin Code	Min.	Max.	Unit	Condition
P	45.0	72.0	mcd	I_F =5mA
Q	72.0	112		

Note:
1. Tolerance of Luminous Intensity: ±11%

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Chromaticity Coordinates Specifications for Bin Grading
T1

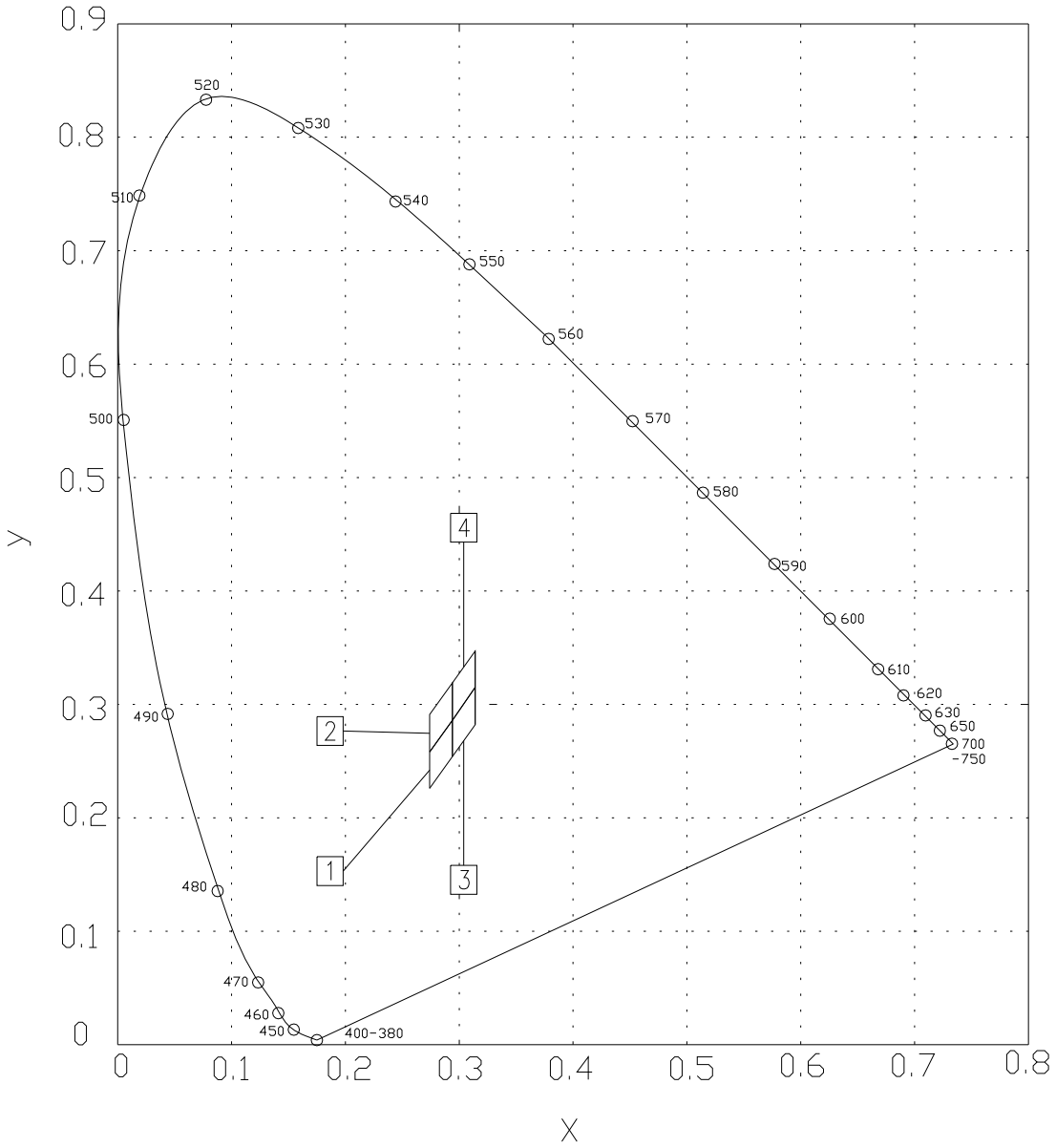
Bin Code	CIE_x	CIE_y	Condition
1	0.274	0.226	I_F =5mA
	0.274	0.258	
	0.294	0.286	
	0.294	0.254	
2	0.274	0.258	
	0.274	0.291	
	0.294	0.319	
	0.294	0.286	
3	0.294	0.254	
	0.294	0.286	
	0.314	0.315	
	0.314	0.282	
4	0.294	0.286	
	0.294	0.319	
	0.314	0.347	
	0.314	0.315	

Notes:
1.The C.I.E. 1931 chromaticity diagram (Tolerance ±0.01).
2.The products are sensitive to static electricity and care must be fully taken when handling products.

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CIE Chromaticity Diagram

T1

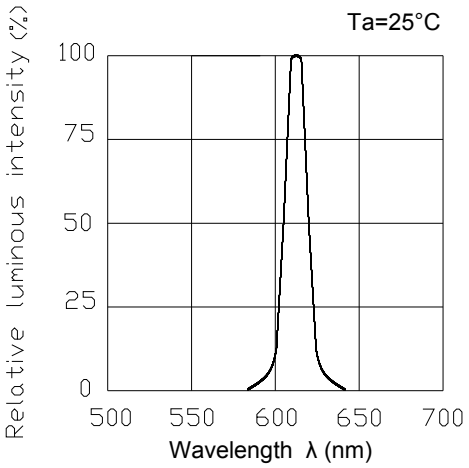


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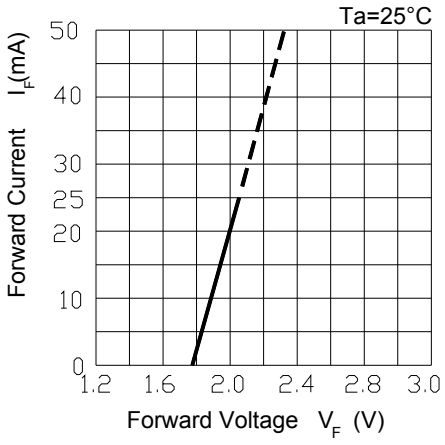
Typical Electro-Optical Characteristics Curves

S2

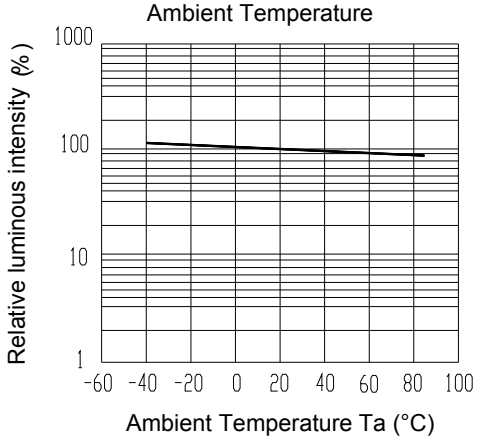
Spectrum Distribution



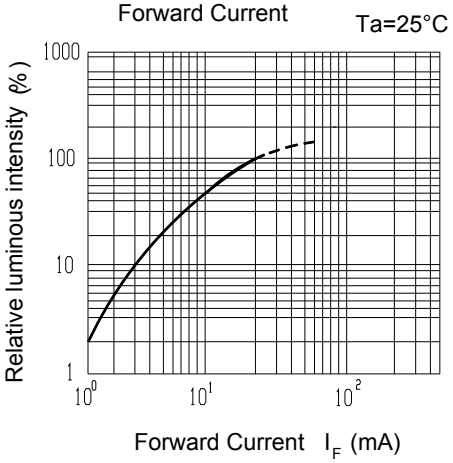
Forward Current vs. Forward Voltage



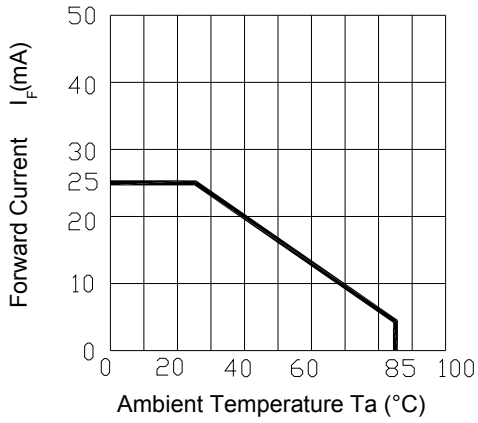
Luminous Intensity vs. Ambient Temperature



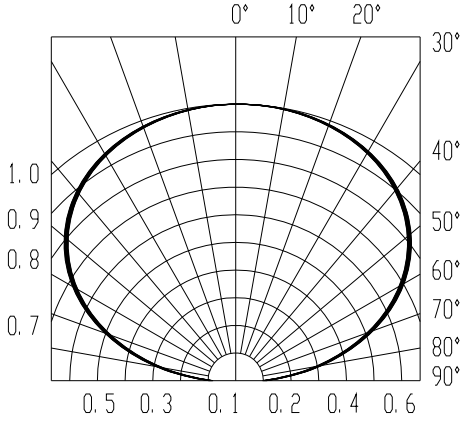
Luminous Intensity vs. Forward Current



Forward Current Derating Curve



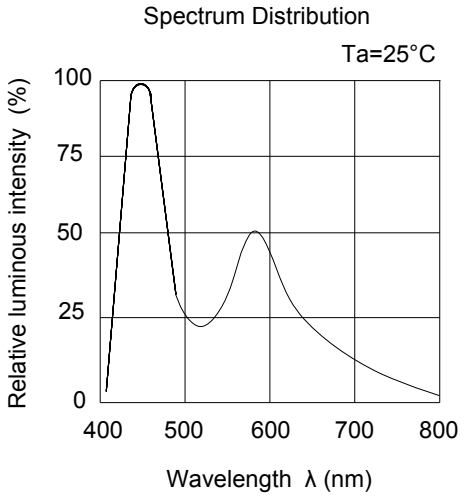
Radiation Diagram

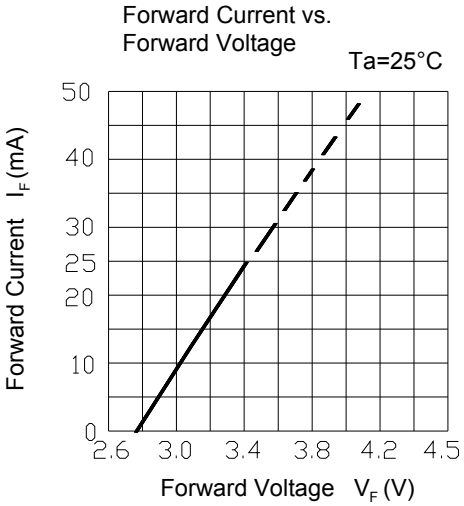


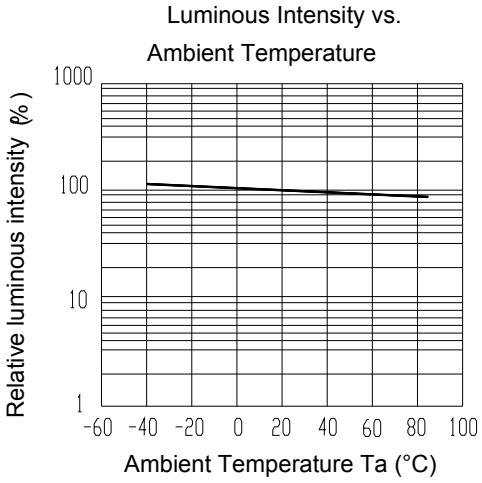
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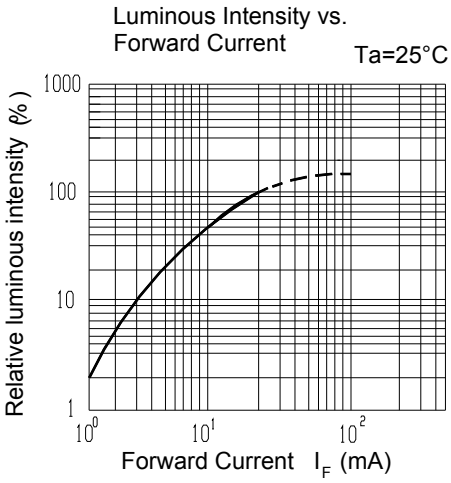
Typical Electro-Optical Characteristics Curves

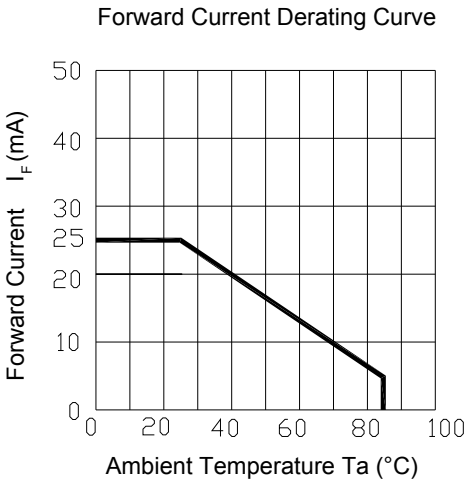
T1

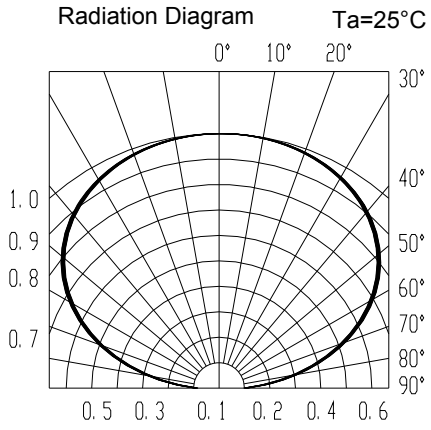






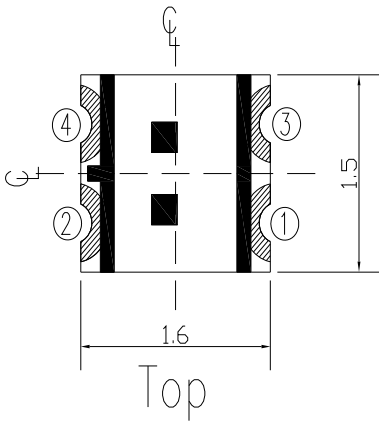


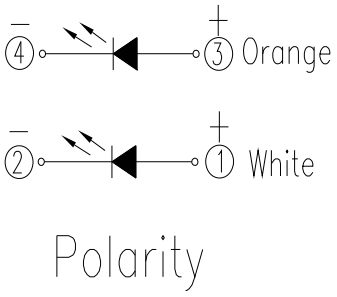


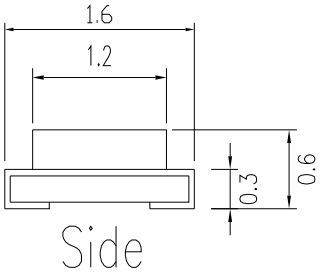


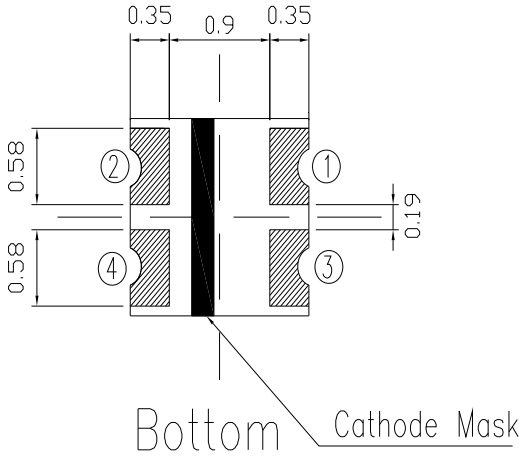
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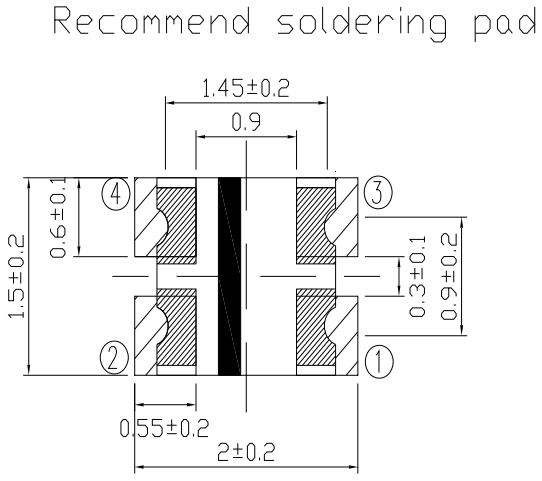
Package Dimension











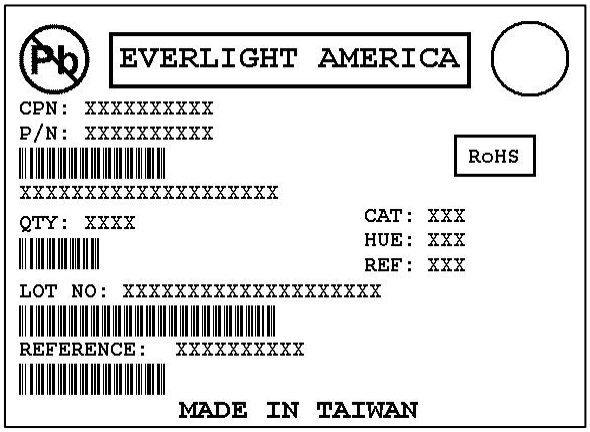
Suggested pad dimension is just for reference only.
Please modify the pad dimension based on individual need.

Note: Tolerances unless mentioned ±0.1mm. Unit = mm

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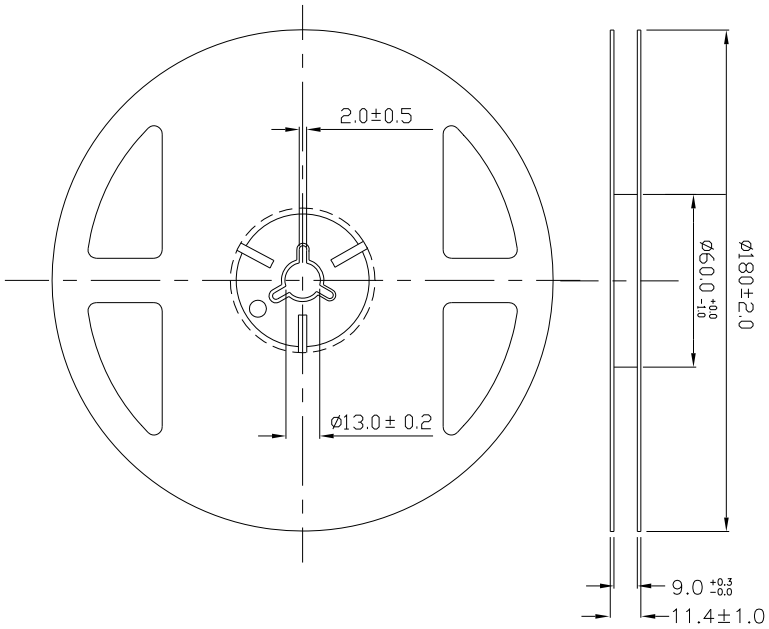
Moisture Resistant Packing Materials

Label Explanation



- CPN: Customer's Product Number
- P/N: Product Number
- QTY: Packing Quantity
- CAT: Luminous Intensity Rank
- HUE: Chromaticity Coordinates & Dom. Wavelength Rank
- REF: Forward Voltage Rank
- LOT No: Lot Number

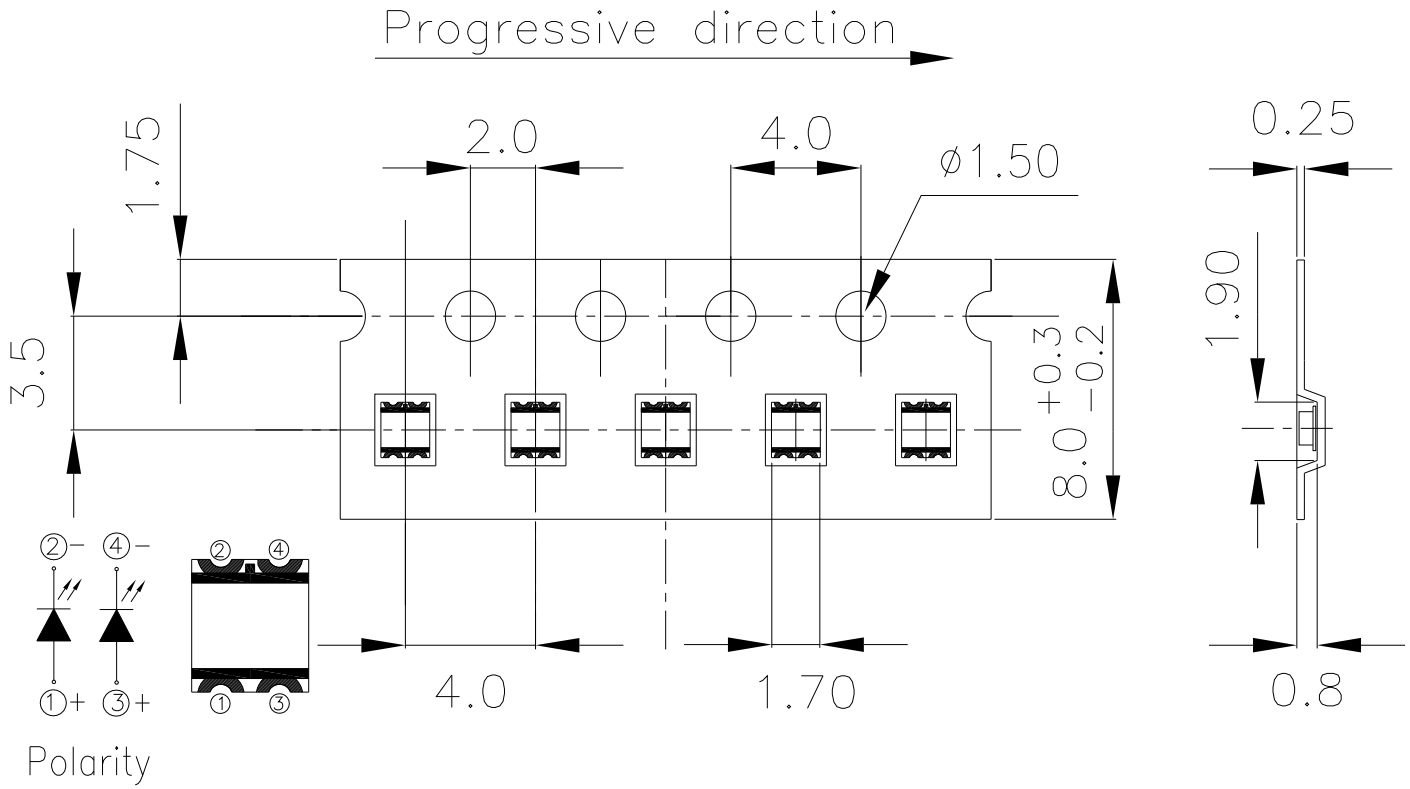
Reel Dimensions



Note: The tolerances unless mentioned is ±0.1mm ,Unit = mm

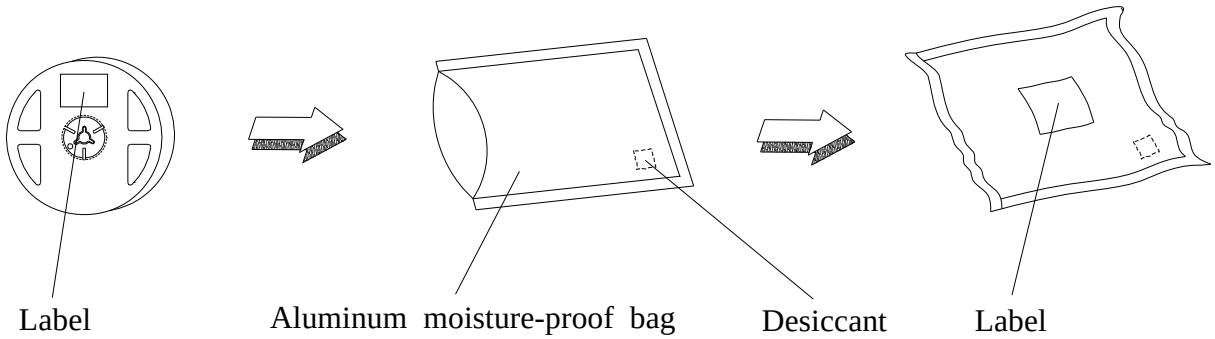
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Carrier Tape Dimensions: Loaded quantity 2000 PCS per reel



Note: The tolerances unless mentioned is ±0.1mm ,Unit = mm

Moisture Resistant Packaging



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Precautions For Use

1. Over-current-proof

Customer must apply resistors for protection, otherwise slight voltage shift will cause big current change (Burn out will happen).

2. Storage

2.1 Do not open moisture proof bag before the products are ready to use.

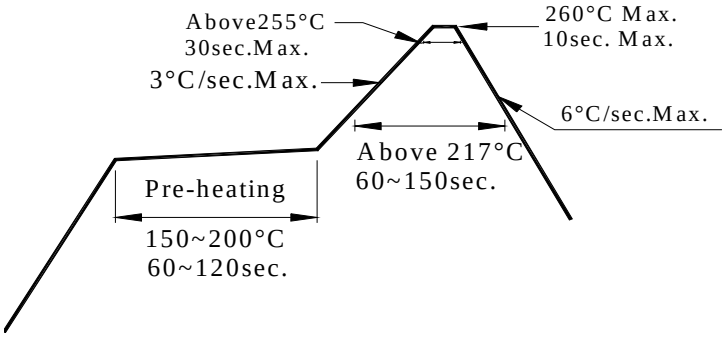
2.2 Before opening the package: The LEDs should be kept at 30℃ or less and 90%RH or less.

2.3 After opening the package: The LED's floor life is 1 year under 30℃ or less and 60% RH or less. If unused LEDs remain, it should be stored in moisture proof packages.

2.4 If the moisture absorbent material (silica gel) has faded away or the LEDs have exceeded the storage time, baking treatment should be performed using the following conditions.
Baking treatment : 60±5℃ for 24 hours.

3. Soldering Condition

3.1 Pb-free solder temperature profile



3.2 Reflow soldering should not be done more than two times.

3.3 When soldering, do not put stress on the LEDs during heating.

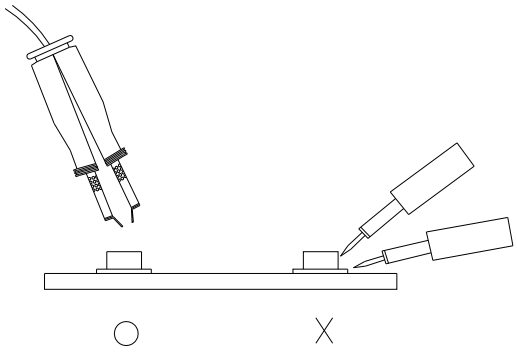
3.4 After soldering, do not warp the circuit board.

4.Soldering Iron

Each terminal is to go to the tip of soldering iron temperature less than 350℃ for 3 seconds within once in less than the soldering iron capacity 25W. Leave two seconds and more intervals, and do soldering of each terminal. Be careful because the damage of the product is often started at the time of the hand solder.

5.Repairing

Repair should not be done after the LEDs have been soldered. When repairing is unavoidable, a double-head soldering iron should be used (as below figure). It should be confirmed beforehand whether the characteristics of the LEDs will or will not be damaged by repairing.



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Application Restrictions

High reliability applications such as military/aerospace, automotive safety/security systems, and medical equipment may require different product. If you have any concerns, please contact Everlight Americas before using this product in your application. This specification guarantees the quality and performance of the product as an individual component. Do not use this product beyond the specification described in this document.

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